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Part Number: [87832-3060](#)
Status: **Active**
Overview: [Milli-Grid™ Connector System](#)
Description: 2.00mm Pitch Milli-Grid™ Header, Surface Mount, Vertical, Shrouded, Lead-Free, 30 Circuits, 0.05µm Gold (Au) Plating, without Locking Window and Center Polarization Slot, without PCB Locator, Tube

Documents:

[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)
[Product Specification PS-87831-027 \(PDF\)](#)

Agency Certification

CSA LR19980
 UL E29179

General

Product Family PCB Headers
 Series [87832](#)
 Application Signal, Wire-to-Board
 Comments Without Cap; Contact Molex for application in automotive industry
 Overview [Milli-Grid™ Connector System](#)
 Product Name Milli-Grid™
 UPC 884982766433

Physical

Breakaway No
 Circuits (Loaded) 30
 Circuits (maximum) 30
 Color - Resin Black
 Durability (mating cycles max) 100
 First Mate / Last Break No
 Flammability 94V-0
 Glow-Wire Compliant No
 Guide to Mating Part No
 Keying to Mating Part Yes
 Lock to Mating Part Yes
 Material - Metal Phosphor Bronze
 Material - Plating Mating Gold
 Material - Plating Termination Tin
 Material - Resin Nylon
 Net Weight 1.348/g
 Number of Rows 2
 Orientation Vertical
 PCB Locator No
 PCB Retention None
 Packaging Type Tube
 Pitch - Mating Interface 2.00mm
 Pitch - Termination Interface 2.00mm
 Plating min - Mating 0.051µm
 Plating min - Termination 1.905µm
 Polarized to PCB No
 Shrouded Fully
 Stackable No
 Surface Mount Compatible (SMC) Yes
 Temperature Range - Operating -55°C to +105°C



EU RoHS

ELV and RoHS Compliant

REACH SVHC

Not Reviewed

Low-Halogen Status

Not Low-Halogen

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[87832Series](#)

Mates With

[50394](#) Wire-to-Board Terminals, [51110](#) Wire-to-Board Crimp Housing, [87568](#) Wire-to-Board IDT Housings, [79107](#) Board-to-Board Top Entry Through Hole Receptacle, [79108](#) Board-to-Board FFC/FPC Top Entry Through Hole Receptacle, [79109](#) Board-to-Board Surface Mount PCB Receptacle

Termination Interface: Style

Through Hole and Surface Mount

Electrical

Current - Maximum per Contact

2A

Voltage - Maximum

125V

Solder Process Data

Duration at Max. Process Temperature (seconds)

10

Lead-free Process Capability

Reflow Capable (SMT only)

Max. Cycles at Max. Process Temperature

1

Process Temperature max. C

260

Material Info

Reference - Drawing Numbers

Product Specification

PS-87831-027

Sales Drawing

SD-87832-006

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